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For $\mathbf{X}$ U.S. and/or $\mathbf{X}$ Foreign Rights
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By X Inventor(s) or Present Owner

### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Doltar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

## ASSIGNOR:

MIN-HWA CHI Type or print name of ASSIGNOR NO.27 Shih-Ping Rdy 6F-27,	YEE-CHIA YEO Type or print name of ASSIGNOR 2 Fur-Chun Street Apt. 1701, Bik. 6840 January Weif St. 14
Hsin-chu, Taiwan, R.O.C.	Address Heinehu, Taiwan, Republic of Chere #05-131 5643684, Singapore
U.S.A. Epublic Hationality	Nationality

CHENMING HU		
Type or print name of ASSIGNOR		
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Address Address Address Address	Roc Republic	of China
		Ŭ
USA		
Nationality		

#### ASSIGNEE:

Taiwan Semiconductor Manufacturing Co. Ltd. 121 Park Ave. 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C. Taiwan, R.O.C. Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

X

an undivided \_\_\_\_\_\_ percent (\_\_\_%) interest for the United States and its territorial possessions (check the following box/f foreign rights are also to be assigned)

and in all foreign countries

the entire right, title and interest

in and to any and all improvements which are disclosed in the invention entitled:

## Silicon Strain Engineering Accomplished Via Use Of Specific Shallow Trench Isolation Fill Materials

# PATENT REEL: 014114 FRAME: 0946

and which is found in

(a)	x	U.S. patent application executed on even date herewith				
(b)		U.S. patent application executed on				
(c)		U.S. application serial no.	filed on			
$\langle \mathbf{d} \rangle$		U.S. patenł no.	issued			
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Jan. 21, 2003 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above

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Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

Title

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**RECORDED: 05/23/2003**